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I hereby certify that this paper or fee is being deposited with the United States Postal Service with sufficient postage "EXPRESS MAIL POST OFFICE TO ADDRESSEE" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to: Assistant Commissioner for Patents, Washington D.C. 20231.
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June 13, 2001

FILE: 2000.045300

TERRY D. MORGAN
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BOX PATENT APPLICATION
Assistant Commissioner for Patents
Washington, DC 20231

RE: *U.S. Patent Application Entitled "METHOD AND APPARATUS FOR CONTROLLING A THICKNESS OF A COPPER FILM"*
Inventor(s): Thomas Sonderman, Scott Bushman and Craig William Christian
Client Reference: TT3258

Sir:

Transmitted herewith for filing are:

- (1) 34-page patent specification with 31 claims and an abstract (also Figures 1-13 on 13 sheets);
- (2) Declarations;
- (3) Assignments and Assignment Cover Sheet;
- (4) Power of Attorneys;

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- (5) Request for Certification under 35 U.S.C. 122(b)(2)(B)(i); and
(6) Authorization to deduct Deposit Account in the amount of the total filing fee (listed below).

All correspondence, notices, official letters and other communications should be directed to **Terry D. Morgan**, Williams, Morgan & Amerson, P.C., 7676 Hillmont, Suite 250, Houston, TX 77040, and all telephone calls should be directed to **Terry D. Morgan** at (713) 934-4050.

FILING FEE CALCULATION

FOR			Small Entity	Large Entity
Total Claims	31 - 20	= 11	x \$9 = \$	or x \$18 = \$ 198.00
Independent Claims	3 - 3	= 0	x \$40 = \$	or x \$80 = \$ 0.00
Multiple Dependent Claim(s)			+ \$135 = \$	or + \$270 = \$
Basic Fee:			+ \$355 = \$	or + \$710 = \$ 710.00
Assignment Recording Fee:	(\$40 per assignee)		+ = \$	+ = \$ 40.00
TOTAL FILING FEES			\$ 0.00	\$ 948.00

Pursuant to 37 C.F.R. § 1.10 the **Applicants request** that the Patent and Trademark Office accept this application and accord a serial number and filing date as of the date this application is deposited with the U.S. Postal Service for Express Mail.

If the check is inadvertently omitted, or should any additional fees under 37 C.F.R. §§ 1.16 to 1.21 be required for any reason relating to the enclosed materials, or should an overpayment be included herein, the Assistant Commissioner is authorized to deduct or credit said fees from or to **Advanced Micro Devices, Inc.'s Deposit Account No. 01-0365/2000.045300/TT3258**.

Please date stamp and return the enclosed postcard to evidence receipt of these materials.

Respectfully submitted,



Terry D. Morgan
Reg. No. 31,181

kd

Encl:

REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)	First Named Inventor		Sonderman et al.
	Title	Method & Apparatus for Controlling a Thickness of a Copper Film	
	Atty Docket Number		2000.045300/TT3258

Burden Hour Statement: This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. **DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.**